Rec'd PCT/PTO 10 MAR 2005

PATENT Attorney Docket No. 232444

COMBINED DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION AND POWER OF ATTORNEY

☐ Declaration Submit ☑ Declaration Submit		ng OR ng (surcharge (37 CFR 1	.16(e)) requi	red)			
As a below named inver	ntor, I hereby decla	re that:					
first, and sole inventor (if only one name i	zenship are as stated bels listed below) or an original claimed and for which a	ginal, first, au	nd joint inv	entor (if plural	names are	
RESIN COMPOSITI	ON AND MULI	TLAYER STRUCTU	RE INCLU	DING TH	E SAME		
the specification of which	eh:						
was :		r 23, 2004 as Applicat (if applicable).					
⊠ was f	iled on <u>June 24, 2</u>	ail No	ial Applicati	able). on No. PC	T/JP2003/0797	78 and was	
I state that I have reviewed and understand the contents of the specification identified above, including the claim(s), as amended by any amendment referred to above.							
I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.							
inventor's or plant bree least one country other t the box, any foreign app certificate(s), or any PC	der's rights certific han the United Sta plication(s) for pate I international app the same subject m	USC 119(a)-(d) or (f), or cate(s), or 365(a) of any tes of America, listed beent, utility model, design lication(s) designating at latter and having a filing	PCT internation of the	ational appose also identify inventor's untry other	plication(s) des tified below, by or plant breed than the Unite	ignating at y checking ler's rights d States of	
Prior Foreign Application		Foreign Filing Date	Priority (Certified Copy		
Number(s) 182340/2002	Country Japan	(MM/DD/YYYY) 06/24/2002	YES 🖂	00 	YES	NO NO	
102340/2002	Japan	0012-H2002	_ 	一片			

In re Appln. of Inoue et al. Attorney Docket No. 232444

As a named inventor, I hereby appoint Leydig, Voit & Mayer, Ltd. to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Customer Number 23460.



I further direct that correspondence concerning this application be directed to Leydig, Voit & Mayer, Ltd.: Customer Number 23460.



PATENT TRADEWARK OFFICE

I declare that all statements made herein of my own knowledge are true, that all statements made on information and belief are believed to be true, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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In re Appln. of Inoue					
Attorney Docket No. 2	32444				
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